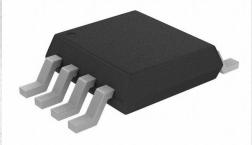


# **MIC2075-2BMM-TR Datasheet**

www.digi-electronics.com



DiGi Electronics Part Number
Manufacturer
Aanufacturer Product Number
Description
Detailed Description

MIC2075-2BMM-TR-DG Microchip Technology MIC2075-2BMM-TR IC PWR SWITCH N-CHAN 1:1 8MSOP Power Switch/Driver 1:1 N-Channel 500mA 8-MSO P

https://www.DiGi-Electronics.com



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RFQ Email: Info@DiGi-Electronics.com

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### Purchase and inquiry

Manufacturer Product Number:Manufacturer:MIC2075-2BMM-TRMicrochip TechnologySeries:Packaging:MMB™Tape & Rel (TR)Part Status:Switch Type:Discontinued at Digi-KeyGeneral PurposeNumber of Outputs:Atio - Input:Output:11:1Output Configuration:VichanelHigh SideNorhanelInterface:Output (Max):On/Off2.7V ~ 5.5VNot RequiredSomARds On (Typ):Output Type:90mOhmMon-InvertingFeatures:SomAStew Rate Controlled, Status FlagGurent Limiting (Fixed), Over Temperature, UVLO
Series:Packaging:MMB™Tape & Reel (TR)Part Status:Switch Type:Discontinued at Digi-KeyGeneral PurposeNumber of Outputs:Ratio - Input: Output:11:1Output Configuration:Output Type:High SideN-ChannelInterface:Otdgae - Load:On/Off2.7V ~ 5.5VVoltage - Supply (Vcc/Vdd):GomANot RequiredSomARds On (Typ):Input Type:90mOhmNon-InvertingFeatures:Soute ContingFeatures:Full Protection:
MMB™Tape & Reel (TR)Part Status:Switch Type:Discontinued at Digi-KeyGeneral PurposeNumber of Outputs:Ratio - Input:Output:11:1Output Configuration:Output Type:High SideN-ChannelInterface:Voltage - Load:On/Off2.7V ~ 5.5VVoltage - Supply (vcc/Vdd):SoomANot RequiredSoomARds On (Typ):Input Type:90m OhmFault Protection:Fauters:Fault Protection:
Part Status:Switch Type:Discontinued at Digi-KeyGeneral PurposeNumber of Outputs:Ratio - Input:Output:11:1Output Configuration:Output Type:High SideN-ChannelInterface:Ovlage - Load:On/Off2.7V~5.5VVoltage - Supply (Vcc/Vdd):Gurmet - Output (Max):Not RequiredSomARds On (Typ):Input Type:90mOhmNon-InvertingFatures:Falt Protection:
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On/Off2.7V ~ 5.5VVoltage - Supply (Vcc/Vdd):Current - Output (Max):Not Required500mARds On (Typ):Input Type:90mOhmNon-InvertingFeatures:Fault Protection:
Voltage - Supply (Vcc/Vdd):Current - Output (Max):Not Required500mARds On (Typ):Input Type:90mOhmNon-InvertingFeatures:Fault Protection:
Not Required     500mA       Rds On (Typ):     Input Type:       90mOhm     Non-Inverting       Features:     Fault Protection:
Rds On (Typ):Input Type:90mOhmNon-InvertingFeatures:Fault Protection:
90mOhm     Non-Inverting       Features:     Fault Protection:
Features: Fault Protection:
Slew Rate Controlled, Status Flag Current Limiting (Fixed), Over Temperature, UVLO
Operating Temperature: Mounting Type:
-40°C ~ 85°C (TA) Surface Mount
Supplier Device Package: Package / Case:
8-MSOP 8-TSSOP, 8-MSOP (0.118", 3.00mm Width)
Base Product Number:
MIC2075

### **Environmental & Export classification**

RoHS Status:	Moisture Sensitivity Level (MSL):
RoHS non-compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8542.39.0060	



### **Single-Channel Power Distribution Switch**

#### Features

- 140 mΩ Maximum On-Resistance
- 2.7V to 5.5V Operating Range
- 500 mA Minimum Continuous Output Current
- · Short-Circuit Protection with Thermal Shutdown
- Fault Status Flag with 3 ms Filter Eliminates False Assertions
- Undervoltage Lockout
- Reverse Current Flow Blocking (No "Body Diode")
- Circuit Breaker Mode (MIC2075) Reduces Power Consumption
- Logic-Compatible Input
- · Soft-Start Circuit
- · Low Quiescent Current
- Pin Compatible with MIC2525
- UL File #E179633

#### **Applications**

- USB Peripherals
- · General Purpose Power Switching
- ACPI Power Distribution
- Notebook PCs
- PDAs
- · PC Card Hot Swap

#### **General Description**

The MIC2025 and MIC2075 are high-side MOSFET switches optimized for general-purpose power distribution requiring circuit protection.

The MIC2025/75 are internally current limited and have thermal shutdown that protects the device and load. The MIC2075 offers "smart" thermal shutdown that reduces current consumption in fault modes. When a thermal shutdown fault occurs, the output is latched off until the faulty load is removed. Removing the load or toggling the enable input will reset the device output.

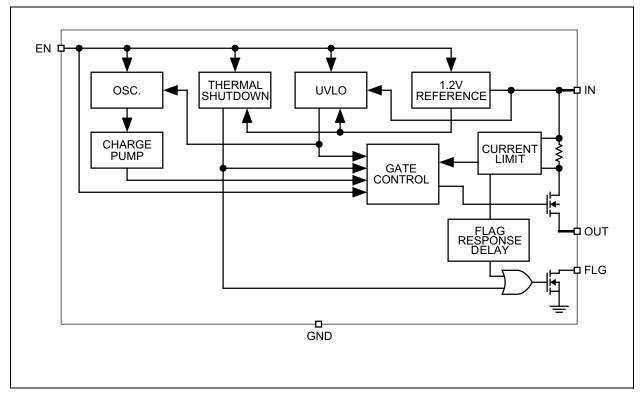
Both devices employ soft-start circuitry that minimizes inrush current in applications where highly capacitive loads are employed. A fault status output flag is provided that is asserted during overcurrent and thermal shutdown conditions.

The MIC2025/75 are available in the 8-Pin MSOP and 8-Pin SOIC packages.

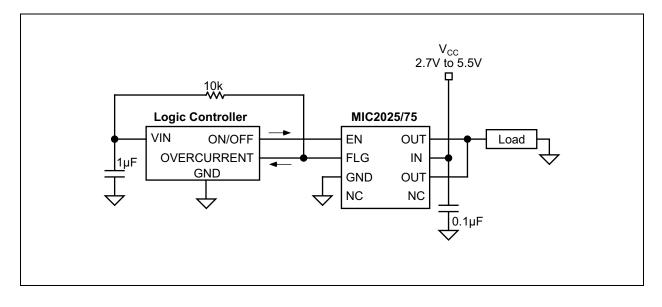
### MIC2025/2075 8-Pin SOIC (YM) 8-Pin MSOP(YMM) MIC2025/75 EN 1 8 OUT FLG 2 7 IN GND 3 6 OUT NC 4 5 NC

#### Package Type

### Functional Block Diagram



#### **Typical Application Circuit**



### 1.0 ELECTRICAL CHARACTERISTICS

#### Absolute Maximum Ratings †

Supply Voltage (V <sub>IN</sub> )	–0.3V to +6V
Fault Flag Voltage (V <sub>FLG</sub> )	+6V
Fault Flag Current (I <sub>FLG</sub> )	25 mA
Output Voltage (V <sub>OUT</sub> )	+6V
Output Current (I <sub>OUT</sub> )	Internally Limited
Enable Input (I <sub>EN</sub> )	–0.3V to V <sub>IN</sub> + 3V
ESD Rating	(Note 1)

### Operating Ratings ‡

Supply Voltage (V <sub>IN</sub> )
-----------------------------------

**† Notice:** Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability. Specifications are for packaged product only.

**‡ Notice:** The device is not guaranteed to function outside its operating ratings.

**Note 1:** Devices are ESD sensitive. Handling precautions are recommended.

#### TABLE 1-1: ELECTRICAL CHARACTERISTICS

**Electrical Characteristics:**  $V_{IN}$  = +5V;  $T_A$  = +25°C, **Bold** values indicate -40°C ≤  $T_A$  ≤ +85°C; unless otherwise specified.

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions
		_	0.75	5	μA	MIC20x5-1, V <sub>EN</sub> ≤ 0.8V (switch off), OUT = open
Supply Current			0.75	5	μA	MIC20x5-2, V <sub>EN</sub> ≥ 2.4V (switch off), OUT = open
Supply Current	I <sub>DD</sub>		_	160	μA	MIC20x5-1, $V_{EN} \ge 2.4V$ (switch on), OUT = open
			_	160	μA	MIC20x5-2, $V_{EN} \le 0.8V$ (switch on), OUT = open
Enable Input Voltage		_	2.1	2.4	V	Low-to-High Transition
Enable input voltage	V <sub>EN</sub>	0.8	1.9		V	High-to-Low Transition
Enable Input Hysteresis		_	200	_	mV	—
Enable Input Current	I <sub>EN</sub>	-1	0.01	1	μA	V <sub>EN</sub> = 0V to 5.5V
Control Input Capacitance	—		1		pF	_
Switch Resistance	Б		90	140	mΩ	V <sub>IN</sub> = 5V, I <sub>OUT</sub> = 500 mA
Switch Resistance	R <sub>DS(ON)</sub>	_	100	160	mΩ	V <sub>IN</sub> = 3.3V, I <sub>OUT</sub> = 500 mA
Output Leakage Current	—	_	—	10	μA	MIC2025/2075 (output off)
OFF Current in Latched Thermal Shutdown	—		50		μA	MIC2075 (during thermal shutdown state)
Output Turn-On Delay	t <sub>ON</sub>	1	2.5	6	ms	$R_L = 10\Omega$ , $C_L = 1 \mu F$ , (see Timing Diagrams)
Output Turn-On Rise Time	t <sub>R</sub>	0.5	2.3	5.9	ms	$R_L = 10\Omega$ , $C_L = 1 \mu F$ , (see Timing Diagrams)
Output Turn-Off Delay	t <sub>OFF</sub>	_	50	100	μs	$R_L = 10\Omega$ , $C_L = 1 \mu F$ , (see Timing Diagrams)

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**Electrical Characteristics:**  $V_{IN}$  = +5V;  $T_A$  = +25°C, **Bold** values indicate -40°C ≤  $T_A$  ≤ +85°C; unless otherwise specified.

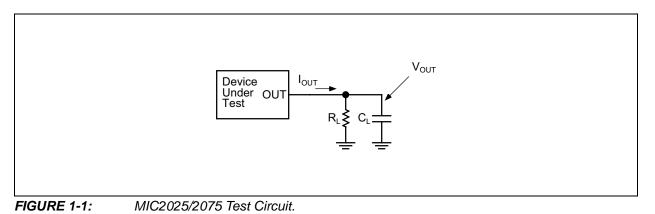
Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions
Output Turn-Off Fall Time	t <sub>F</sub>	_	50	100	μs	$R_L = 10\Omega$ , $C_L = 1 \mu$ F, (see Timing Diagrams)
Short-Circuit Output Current	I <sub>LIMIT</sub>	0.5	0.7	1.25	А	V <sub>OUT</sub> = 0V, enabled into short-circuit
Current-Limit Threshold (See Figure 2-22)	—	0.60	0.85	1.25	А	Ramped load applied to output
Short-Circuit Response Time	_	_	24		μs	V <sub>OUT</sub> = 0V to I <sub>OUT</sub> = I <sub>LIMIT</sub> (short applied to output)
Overcurrent Flag Response Delay		1.5	3	7	ms	V <sub>IN</sub> = 5V, apply V <sub>OUT</sub> = 0V until FLG low
	t <sub>D</sub>	1.5	3	8	ms	V <sub>IN</sub> = 3.3V, apply V <sub>OUT</sub> = 0V until FLG low
Undervoltage Lockout		2.2	2.5	2.7	V	V <sub>IN</sub> Rising
Threshold		2.0	2.3	2.5	V	V <sub>IN</sub> Falling
Error Elog Output Desistance		—	8	25	Ω	I <sub>L</sub> = 10 mA, V <sub>IN</sub> = 5V
Error Flag Output Resistance			11	40	Ω	I <sub>L</sub> = 10 mA, V <sub>IN</sub> = 3.3V
Error Flag Off Current		_	_	10	μA	V <sub>FLAG</sub> = 5V
Quartemporature Thrasheld		_	140		°C	T <sub>J</sub> increasing
Overtemperature Threshold			120		°C	T <sub>J</sub> decreasing

### **TEMPERATURE SPECIFICATIONS (Note 1)**

Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions
Temperature Ranges						
Storage Temperature Range	Τ <sub>S</sub>	-65	_	+150	°C	—
Ambient Temperature Range	T <sub>A</sub>	-40	—	+85	°C	—
Junction Temperature Range	TJ	—	—	—	°C	Internally Limited
Package Thermal Resistances						
Thermal Resistance SOIC 8-LD	$\theta_{JA}$	_	160	_	°C/W	—
Thermal Resistance MSOP 8-LD	$\theta_{JA}$	—	206	_	°C/W	—

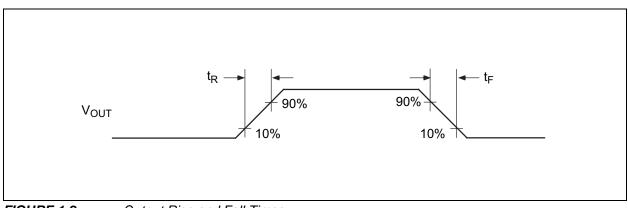
**Note 1:** The maximum allowable power dissipation is a function of ambient temperature, the maximum allowable junction temperature and the thermal resistance from junction to air (i.e., T<sub>A</sub>, T<sub>J</sub>, θ<sub>JA</sub>).

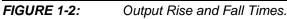
#### **Test Circuit**



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### **Timing Diagrams**





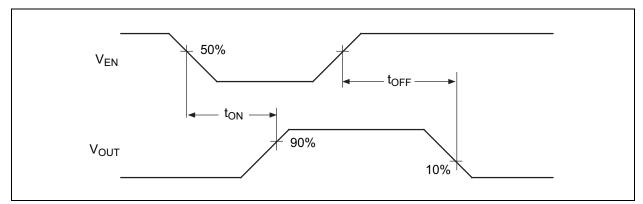


FIGURE 1-3: Active-Low Switch Delay Time (MIC20x5-2).

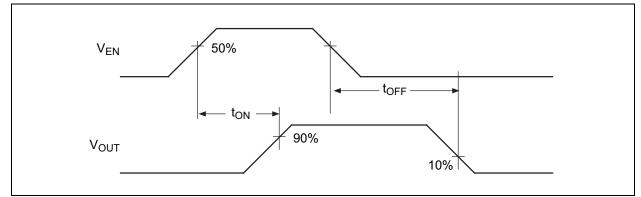
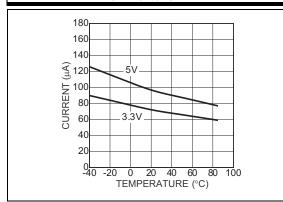
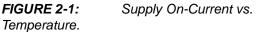


FIGURE 1-4: Active-High Switch Delay Times (MIC20x5-1).

### 2.0 TYPICAL PERFORMANCE CURVES

**Note:** The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.





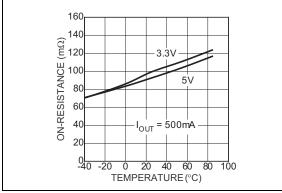


FIGURE 2-2: On-Resistance vs. Temperature.

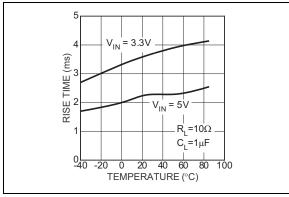


FIGURE 2-3: Turn-On rise Time vs. Temperature.

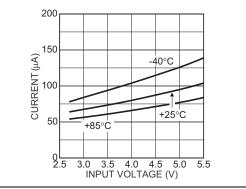


FIGURE 2-4: Suppl Voltage.

Supply On-Current vs. Input

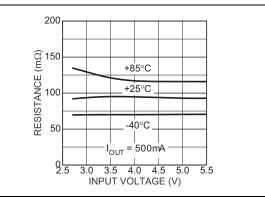


FIGURE 2-5: On-I

On-Resistance vs. Input

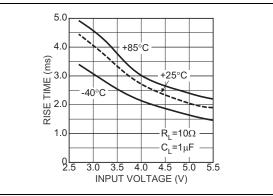


FIGURE 2-6: Turn Voltage.

Turn-On Rise Time vs. Input

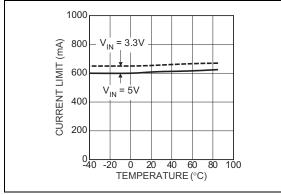


FIGURE 2-7: Short-Circuit Current-Limit vs. Temperature.

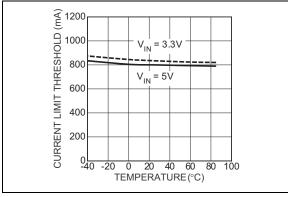
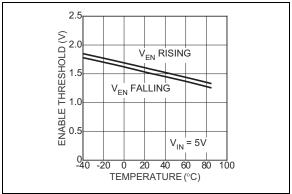


FIGURE 2-8: Temperature.

Current-Limit Threshold vs.



*FIGURE 2-9:* Enable Threshold vs. Temperature.

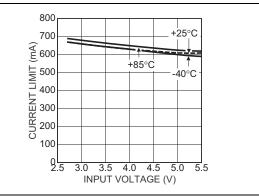


FIGURE 2-10: Short-Circuit Current-Limit vs. Input Voltage.

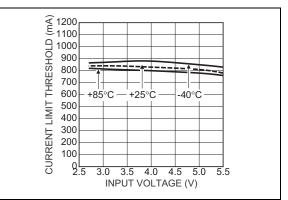


FIGURE 2-11: Current-Limit Threshold vs. Input Voltage.

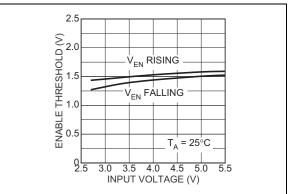


FIGURE 2-12: Enable Threshold vs. Input Voltage.



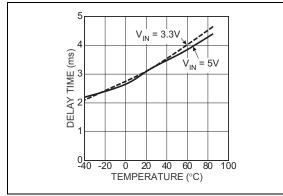


FIGURE 2-13: Flag Delay vs. Temperature.

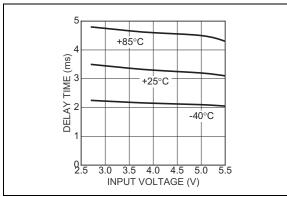


FIGURE 2-14: Flag Delay vs. Input Voltage.

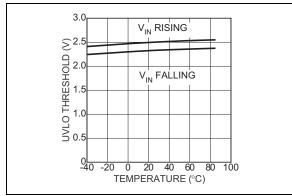
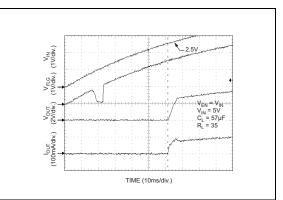
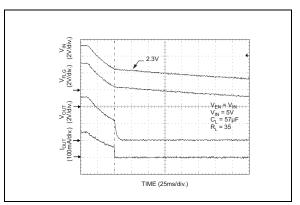


FIGURE 2-15: UVLO Threshold vs. Temperature.



**FIGURE 2-16:** UVLO V<sub>IN</sub> Rising (MIC2025-1).



**FIGURE 2-17:** UVLO V<sub>IN</sub> Falling (MIC2025-1).

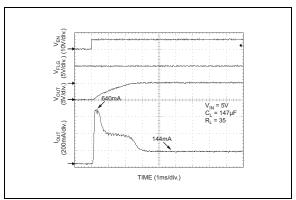


FIGURE 2-18: (MIC2025-1).

Turn-On Response

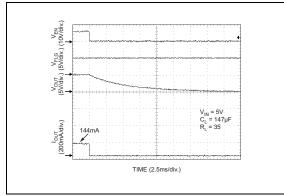


FIGURE 2-19: Turn-Off Response (MIC2025-1).

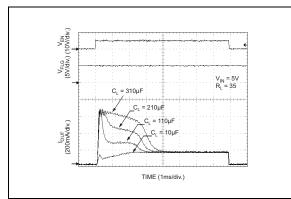


FIGURE 2-20: In-Ru (MIC2025-1).

In-Rush Current Response

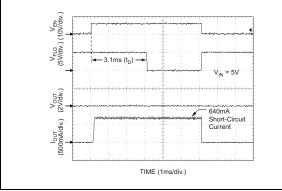


FIGURE 2-21: Enable Into Short (MIC2025-1).

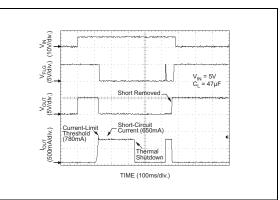
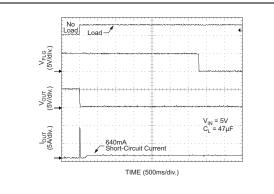


FIGURE 2-22:Current-Limit Response(Ramped Load Into Short MIC2025-1).



*FIGURE 2-23:* Current-Limit Transient Response (Enable Into Short MIC2025-1).

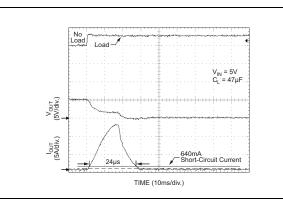
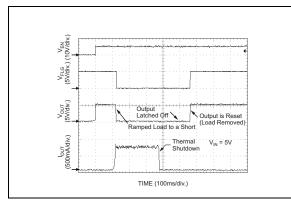
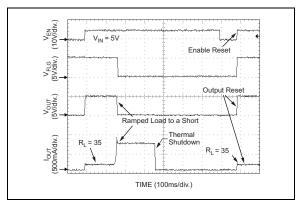


FIGURE 2-24: Current-Limit Transient Response (MIC2025-1).





**FIGURE 2-25:** Thermal Shutdown Response (Output Reset By Removing Load MIC2075-1).



**FIGURE 2-26:** Thermal Shutdown Response (Output Reset By Toggling Enable MIC2075-1).

### 3.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 3-1.

#### TABLE 3-1:PIN FUNCTION TABLE

Pin Number	Pin Name	Description
1	EN	Switch Enable (Input): Active-high (-1) or Active-low (-2).
2	FLG	Fault Flag (Output): Active-low, open-drain output. Indicates overcurrent or thermal shutdown conditions. Overcurrent condition must exceed $t_D$ in order to assert FLG.
3	GND	Ground.
4	NC	Not internally connected.
5	NC	Not internally connected.
6, 8	OUT	Supply (Output): Pins must be connected together.
7	IN	Supply voltage (Input).

### 4.0 FUNCTIONAL DESCRIPTION

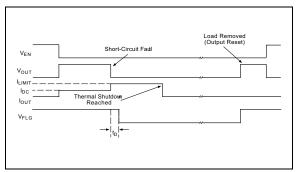
#### 4.1 Input and Output

IN is the power supply connection to the logic circuitry and the drain of the output MOSFET. OUT is the source of the output MOSFET. In a typical circuit, current flows from IN to OUT toward the load. If V<sub>OUT</sub> is greater than V<sub>IN</sub>, current will flow from OUT to IN, since the switch is bidirectional when enabled. The output MOSFET and driver circuitry are also designed to allow the MOSFET source to be externally forced to a higher voltage than the drain (V<sub>OUT</sub> > V<sub>IN</sub>) when the switch is disabled. In this situation, the MIC2025/75 prevents undesirable current flow from OUT to IN.

#### 4.2 Thermal Shutdown

Thermal shutdown is employed to protect the device from damage should the die temperature exceed safe margins due mainly to short circuit faults. Thermal shutdown shuts off the output MOSFET and asserts the FLG output if the die temperature reaches 140°C. The MIC2025 will automatically reset its output should the die temperature cool down to 120°C. The MIC2025 output and FLG signal will continue to cycle on and off until the device is disabled or the fault is removed. Figure 4-2 depicts typical timing. If the MIC2075 goes into thermal shutdown, its output will latch off and a pull-up current source is activated. This allows the output latch to automatically reset when the load (such as a USB device) is removed. The output can also be reset by toggling EN. Refer to Figure 4-1 for details.

Depending on PCB layout, package, ambient temperature, etc., it may take several hundred milliseconds from the incidence of the fault to the output MOSFET being shut off. The worst-case scenario of thermal shutdown is that of a short-circuit fault and is shown in Figure 2-25 and Figure 2-26.



*FIGURE 4-1:* MIC2075-2 Timing: Output Reset by Removing Load.

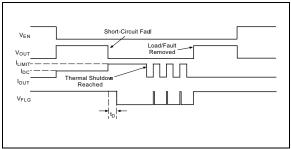


FIGURE 4-2: MIC2025-2 Timing.

#### 4.3 Power Dissipation

The device's junction temperature depends on several factors such as the load, PCB layout, ambient temperature, and package type. Equations that can be used to calculate power dissipation and junction temperature are found in Equation 4-1 and Equation 4-2.

#### **EQUATION 4-1:**

$$P_D = R_{DS(on)} \times I_{OUT}^2$$

**EQUATION 4-2:** 

$$T_I = P_D \times \Theta_{IA} + T_A$$

Where:

 $T_J =$  Junction Temperature  $T_A =$  Ambient Temperature

 $\theta_{IA}$  = The Thermal Resistance of the

Package

#### 4.4 Current Sensing and Limiting

The current-limit threshold is preset internally. The preset level prevents damage to the device and external load but still allows a minimum current of 500 mA to be delivered to the load.

The current-limit circuit senses a portion of the output MOSFET switch current. The current-sense resistor shown in the Functional Block Diagram is virtual and has no voltage drop. The reaction to an overcurrent condition varies with three scenarios:

#### 4.4.1 SWITCH ENABLED INTO SHORT-CIRCUIT

If a switch is enabled into a heavy load or short-circuit, the switch immediately enters into a constant-current mode, reducing the output voltage. The FLG signal is asserted indicating an overcurrent condition. See Figure 2-21.

#### 4.4.2 SHORT-CIRCUIT APPLIED TO ENABLED OUTPUT

When a heavy load or short-circuit is applied to an enabled switch, a large transient current may flow until the current-limit circuitry responds. Once this occurs, the device limits current to less than the short-circuit current limit specification. See Figure 2-23.

#### 4.4.3 CURRENT-LIMIT RESPONSE -RAMPED LOAD

The MIC2025/75 current-limit profile exhibits a small foldback effect of about 200 mA. Once this current-limit threshold is exceeded the device switches into a constant current mode. It is important to note that the device will supply current until the current-limit threshold is exceeded. See Figure 2-22.

### 4.5 Fault Flag

The FLG signal is an N-channel open-drain MOSFET output. FLG is asserted (active-low) when either an overcurrent or thermal shutdown condition occurs. In the case of an overcurrent condition, FLG will be asserted only after the flag response delay time,  $t_D$ , has elapsed. This ensures that FLG is asserted only upon valid overcurrent conditions and that erroneous error reporting is eliminated. For example, false overcurrent conditions can occur during hot plug events when a highly capacitive load is connected and causes a high transient inrush current that exceeds the current-limit threshold. The FLG response delay time  $t_D$  is typically 3 ms.

#### 4.6 Undervoltage Lockout

Undervoltage lockout (UVLO) prevents the output MOSFET from turning on until  $V_{\rm IN}$  exceeds approximately 2.5V. Undervoltage detection functions only when the switch is enabled.

### 5.0 APPLICATION INFORMATION

#### 5.1 Supply Filtering

A 0.1  $\mu$ F to 1  $\mu$ F bypass capacitor positioned close to VIN and GND of the device is strongly recommended to control supply transients. Without a bypass capacitor, an output short may cause sufficient ringing on the input (from supply lead inductance) to damage internal control circuitry.

#### 5.2 Printed Circuit Board Hot-Plug

The MIC2025/75 are ideal inrush current-limiters for hot plug applications. Due to their integrated charge pumps, the MIC2025/75 present a high impedance when off and slowly become a low impedance as their integrated charge pumps turn on. This soft-start feature effectively isolates power supplies from highly capacitive loads by reducing inrush current. Equation 5-1 shows how the MIC2075 may be used in a card hot-plug application.

In cases of extremely large capacitive loads (>400  $\mu$ F), the length of the transient due to inrush current may exceed the delay provided by the integrated filter. Since this inrush current exceeds the current-limit delay specification, FLG will be asserted during this time. To prevent the logic controller from responding to FLG being asserted, an external RC filter, as shown in Equation 5-2, can be used to filter out transient FLG assertion. The value of the RC time constant should be selected to match the length of the transient, less t<sub>D(min)</sub> of the MIC2025/75.

#### 5.3 Universal Serial Bus (USB) Power Distribution

The MIC2025/75 are ideally suited for USB (Universal Serial Bus) power distribution applications. The USB specification defines power distribution for USB host systems such as PCs and USB hubs. Hubs can either be self-powered or bus-powered (that is, powered from the bus). Equation 5-3 shows a typical USB Host application that may be suited for mobile PC applications employing USB. The requirement for USB host systems is that the port must supply a minimum of 500 mA at an output voltage of 5V ±5%. In addition, the output power delivered must be limited to below 25 VA. Upon an overcurrent condition, the host must also be notified. To support hot-plug events, the hub must have a minimum of 120 µF of bulk capacitance, preferably low ESR electrolytic or tantalum. Please refer to Application Note 17 for more details on designing compliant USB hub and host systems.

For bus-powered hubs, USB requires that each downstream port be switched on or off under control by the host. Up to four downstream ports each capable of supplying 100 mA at 4.4V minimum are allowed. In addition, to reduce voltage droop on the upstream

 $V_{BUS}$ , soft-start is necessary. Although the hub can consume up to 500 mA from the upstream bus, the hub must consume only 100 mA max at start-up, until it enumerates with the host prior to requesting more power. The same requirements apply for bus-powered peripherals that have no downstream ports. Equation 5-4 shows a bus-powered hub.

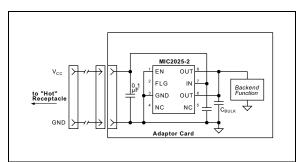
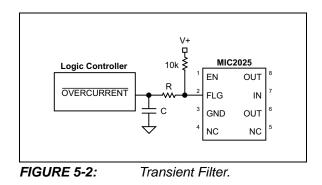
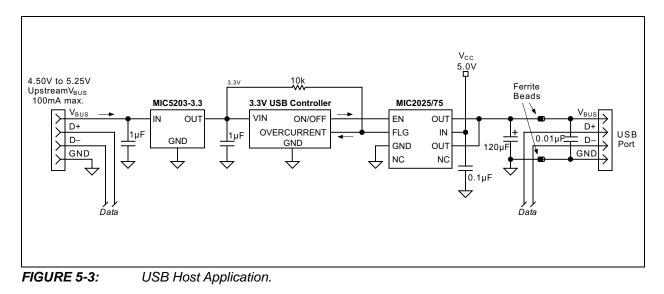


FIGURE 5-1: Hot-Plug Application.





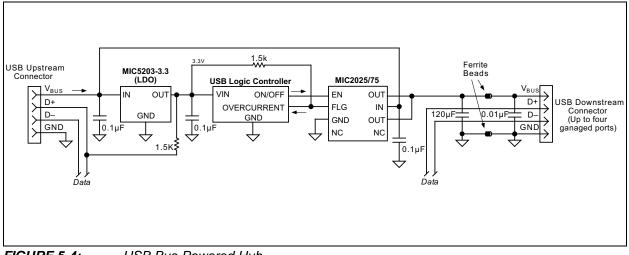
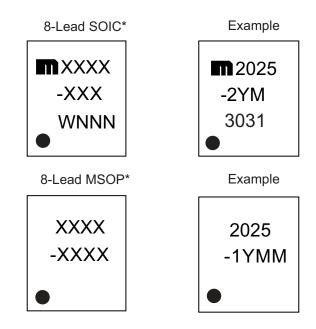


FIGURE 5-4: USB Bus-Powered Hub.

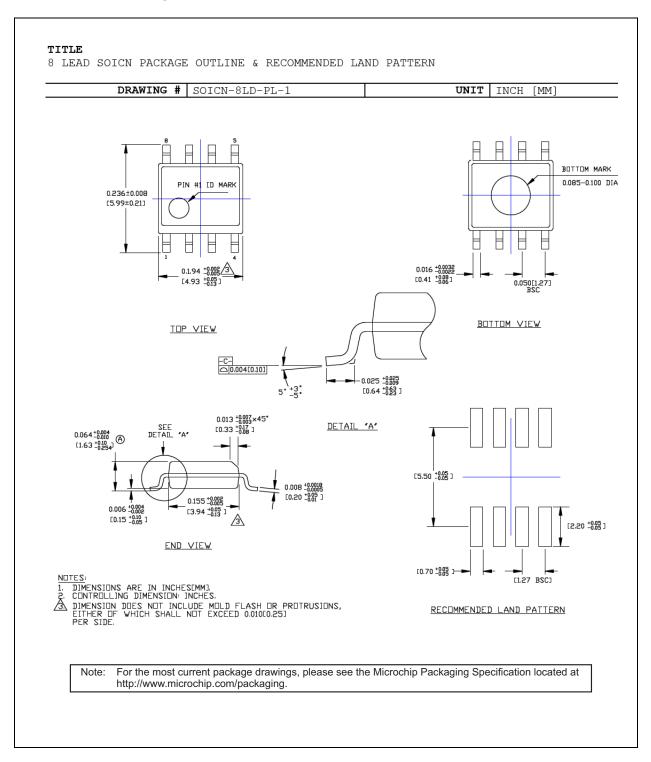
### 6.0 PACKAGING INFORMATION

#### 6.1 Package Marking Information

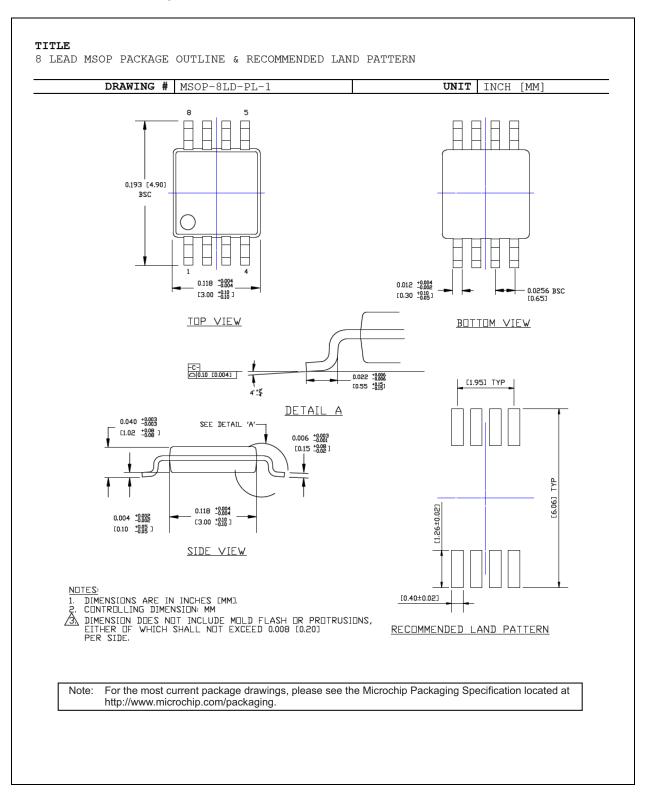


<ul> <li>Legend: XXX Product code or customer-specific information         <ul> <li>Y Year code (last digit of calendar year)</li> <li>YY Year code (last 2 digits of calendar year)</li> <li>WW Week code (week of January 1 is week '01')</li> <li>NNN Alphanumeric traceability code                 <ul> <li>@3 Pb-free JEDEC<sup>®</sup> designator for Matte Tin (Sn)</li> <li>* This package is Pb-free. The Pb-free JEDEC designator (@3)</li> <li>can be found on the outer packaging for this package.</li> <li>, ▲, ▼ Pin one index is identified by a dot, delta up, or delta down (triangle mark).</li> </ul> </li> </ul> </li> <li>Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information. Package may or may not include the corporate logo.</li></ul>			
be carried over to the next line, thus limiting the number of available characters for customer-specific information. Package may or may not include the corporate logo.	Legenc	Y YY WW NNN @3 *	Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code Pb-free JEDEC <sup>®</sup> designator for Matte Tin (Sn) This package is Pb-free. The Pb-free JEDEC designator (€3) can be found on the outer packaging for this package.
	Note:	be carried characters the corpora	d over to the next line, thus limiting the number of available for customer-specific information. Package may or may not include ate logo.

#### 8-Lead SOIC-8 Package Outline and Recommended Land Pattern



#### 8-Lead MSOP-8 Package Outline and Recommended Land Pattern



### APPENDIX A: REVISION HISTORY

#### Revision A (June 2018)

- Converted Micrel document MIC2025/2075 to Microchip data sheet DS20006030A.
- Minor text changes throughout.

NOTES:

### **PRODUCT IDENTIFICATION SYSTEM**

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

						Example	es:	
PART NO. Device	_X T Control/	X T Junction	XX   Package	<u>–XX</u>   Media Ty	oe	a) MIC20	95 1VM-	Single Channel Power Distribution
		emperature Range	-			a) MIC2025-1YM:		Switch, Active-High Control Enable, -40°C to +85°C Temp. Range, 8-Lead SOIC Package, 95/Tube
Device:	MIC2025: MIC2075:		nel Power Di	stribution Sw		b) MIC20	25-2YMM:	Single Channel Power Distribution Switch, Active-Low Control Enable, –40°C to +85°C Temp. Range, 8-Lead MSOP Package, 100/Tube
Control/Enable:	1 = 2 = Y =	Active-High Active-Low –40°C to +85		ompliant Db		c) MIC20	25-1YM-TR:	Single Channel Power Distribution Switch, Active-High Control Enable, –40°C to +85°C Temp. Range, 8-Lead SOIC Package,
Temperature Range	e: M =	Free, Haloge 8-Lead SOI0	n Free)	Jinpilant, FD-		d) MIC20	25-2YMM-TR:	2,500/Reel Single Channel Power Distribution Switch, Active-Low Control Enable, -40°C to +85°C Temp. Range,
	MM =	8-Lead MSC	)P			e) MIC20	075-1YM	8-Lead MSOP Package, 2,500/ Reel Single Channel Power Distribution
Media Type:	Blank = Blank = TR =	95/Tube 100/Tube 2,500/Reel					Switch with Circuit Breaker Mode, Active-High Control Enable, -40°C to +85°C Temp. Range, 8-Lead SOIC Package, 95/Tube	
						f) MIC207	75-1YM-TR:	Single Channel Power Distribution Switch with Circuit Breaker Mode, Active-High Control Enable, –40°C to +85°C Temp. Range, 8-Lead SOIC Package, 2,500/Reel
						g) MIC20	75-2YMM-TR:	Single Channel Power Distribution Switch with Circuit Breaker Mode, Active-Low Control Enable, –40°C to +85°C Temp. Range,8-Lead MSOP Package, 2,500/Reel
						Note 1:	catalog part n used for order the device pa	I identifier only appears in the umber description. This identifier is ring purposes and is not printed on ckage. Check with your Microchip or package availability with the option.

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